MTCON NECTIVITY

POWER SOCKET M4

INTERNAL THREAD,
SMD SOLDERING TECHNOLOGY,
THROUGH HOLE

COMMERCIAL DATA

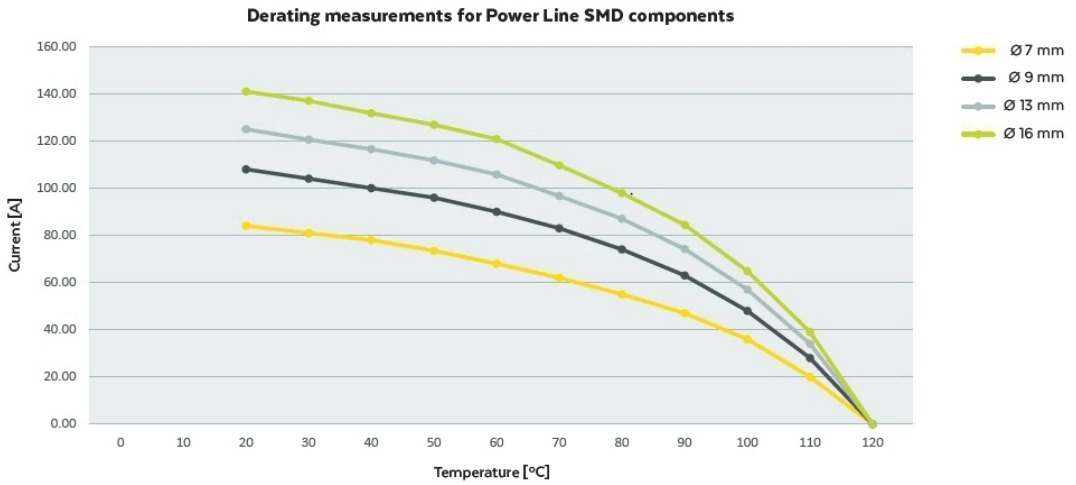
Part number	**02.6.0067**

Packing Unit tape and reel - 2.6.0067.GU10	**430 pieces**
Customs tariff number	**85369010**
Mass	**3,33 g**
Country of origin	**DE (Germany)**

TECHNICAL DATA

Current carrying capacity	**ca. 120 A at 20°C / ca. 70 A at 85° C**
Material	**CuZn39Pb3**
Surface	**matt tinned**

Derating curves are snapshots under test conditions!
Testing was undertaken using two-layer circuit with 70µm copper.



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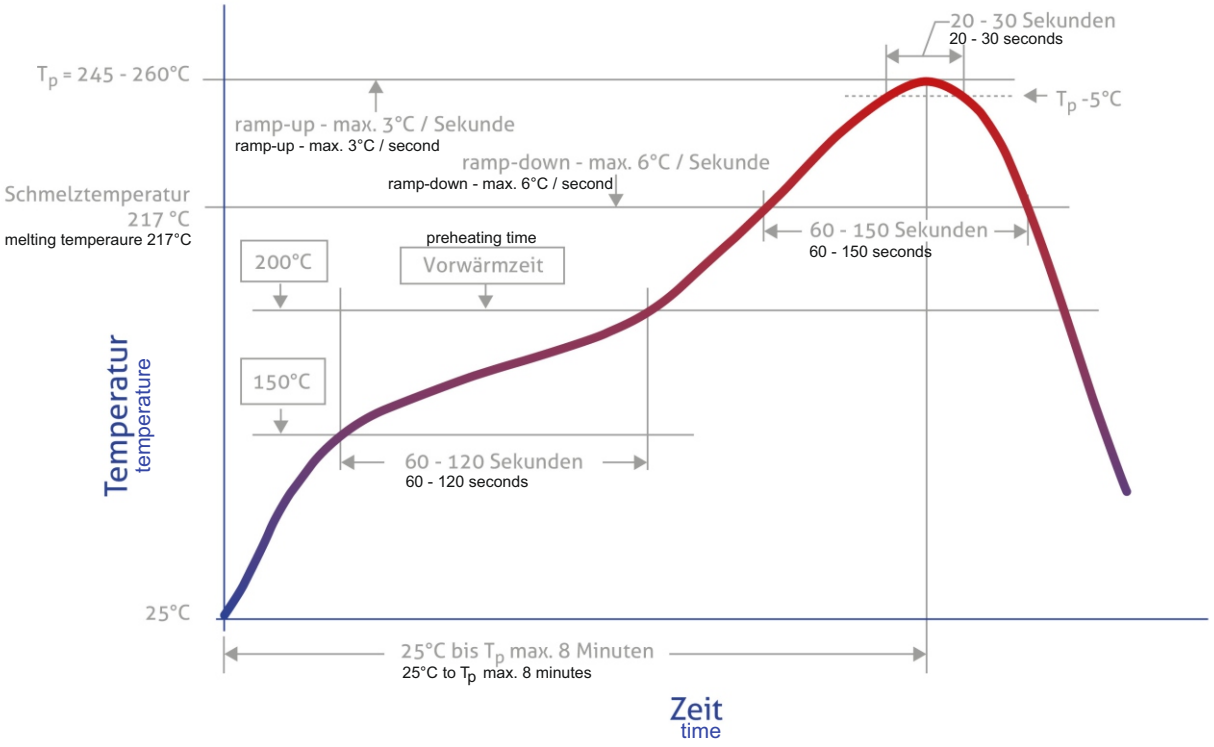
PROCESSING

Torque	**0,8 Nm**
Solder paste thickness	**150 µm**
Operating temperature	**-55°C to 150°C**

SOLDER PROFILE



Reflow Temperatur in Abhängigkeit der Leiterplattendicke:

Reflow temperature depanding on the thickness of the printed circuit board:

Eigenschaften properties	Volumen mm³ <350 volume mm³ < 350	Volumen mm³ 350-2000 volume mm³ 350-2000	Volumen mm³ >2000 volume mm³ > 2000
Leiterplattendicke (Bleifrei) < 1.6 mm PCB thickness (lead free) < 1.6 mm	260 °C	260 °C	260 °C
Leiterplattendicke (Bleifrei) 1.6 mm - 2.5 mm PCB thickness (lead free) 1.6 mm -2.5 mm	260 °C	250 °C	245 °C
Leiterplattendicke (Bleifrei) ≥ 2.5 mm PCB thickness (lead free) ≥ 2.5 mm	250 °C	245 °C	245 °C

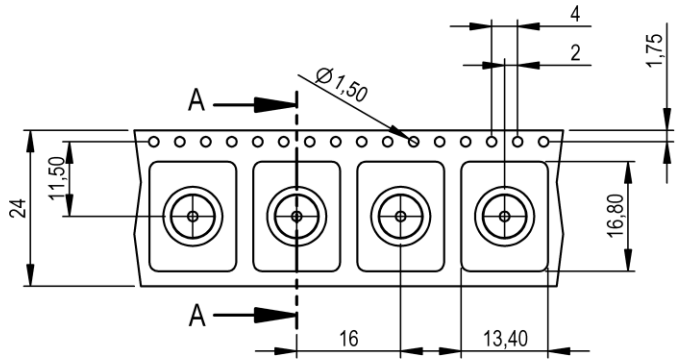
mit Bezug auf IPC/JEDEC J-STD-020D
regarding IPC/JEDEC J-STD-020D

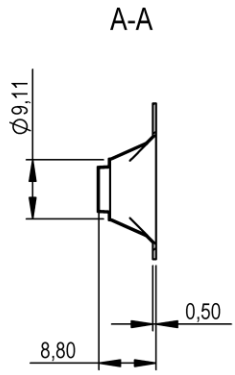
CONFORMITY

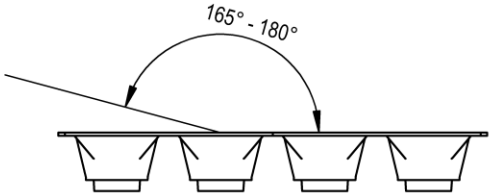
- RoHS compliant

RoHS COMPLIANT

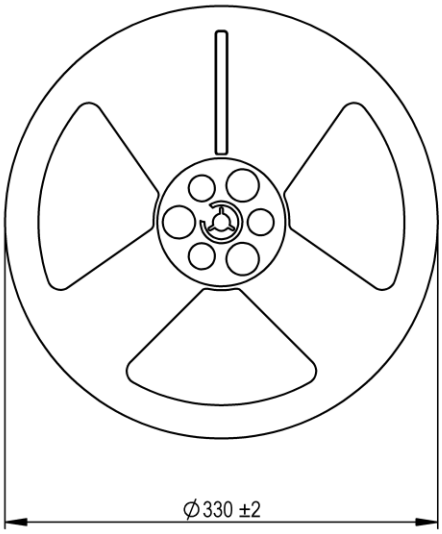
TAPE AND REEL

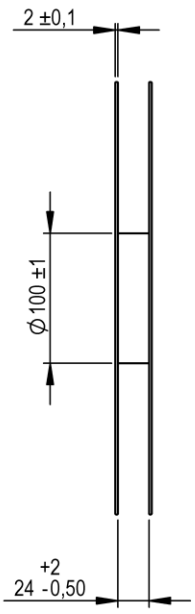




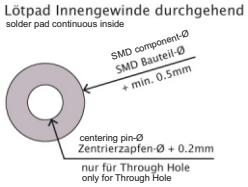


Packaging according IEC 60286-3:2007
Tape-Breite / tape width: 24 mm
pull-out-force: 0,1 N - 1,3 N
no components in the first min. 100mm
no components in the last min. 160mm





LAYOUT



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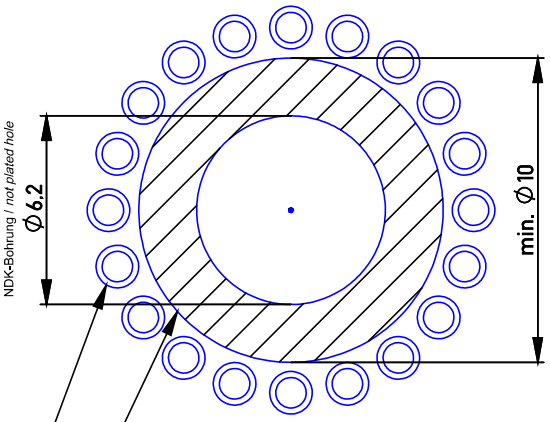
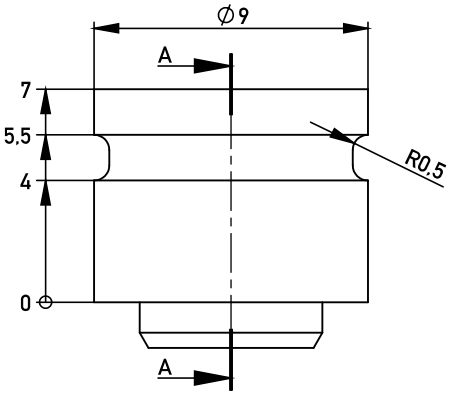
LAYOUT

Verpackung / *packaging*	Artikelnummer / *part number*
lose / *bulk*	02.6.0067
tape and reel	02.6.0067.GU10

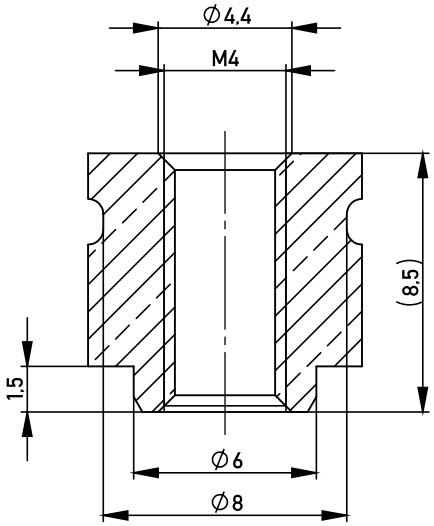


Empfehlung Lötpad / *recommendation solder pad*
vollflächiges Pad min. 0.5mm umlaufend größer als Element /
full-face pad all round min. 0.5mm bigger than the element

optionale DK-Bohrungen umlaufend um das Pad - für höhere Stromtragfähigkeit /
optional plated holes around the pad - for higher current ratings



cut A-A
SCHNITT A-A



RoHS COMPLIANT

Ausführung: SMD
Max. Drehmoment: 0,8 Nm
Gewicht: 3,33 g
Technische Änderungen vorbehalten

execution: SMD
max. torque: 0,8 Nm
weight: 3,33 g
technical subject to change

Werkstoff / *material*	CuZn39Pb3
Oberfläche / *surface plating*	matt verzinnt / *mat tin-plated*
Prozessbedingte Fehlstellen in Galvanik möglich! / *imperfections during electro plating process possible!*	

Toleranz / *tolerance*
DIN ISO 2768-mH

all dimensions in mm

Maßstab / *scale* 5:1

Zeichnungsnummer / *drawing number*
02.6.0067

	Datum / *date*	Name / *name*
Bearb. / *drawer*	27.02.2017	
gepr. / *auth.*		
geän. / *mod.*		

Benennung / description

Power Socket M4
SMD, 9er rund, through hole
SMD, nines round, through hole

Index	Änderung / *modification*	Datum / *date*	Name / *name*
	REACH entfernen	17.07.2018	
A	Neuerstellung	27.02.2017	

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